Amendments to the Specification

Please amend the title as follows

SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING

SEMICONDUCTOR DEVICE-HAVING HIGH BREAKDOWN VOLTAGE WITHOUT

INCREASED ON RESISTANCE

Please amend the paragraph beginning at page 1, line 4 as follows:

This application is a divisional application of U.S. Patent Application Serial No. 10/118,930, which is based on and incorporates herein by reference Japanese Patent Applications No. 2001-120163 filed on April 18, 2001.